

# NCE6005S

## NCE N-Channel Enhancement Mode Power MOSFET

#### **Description**

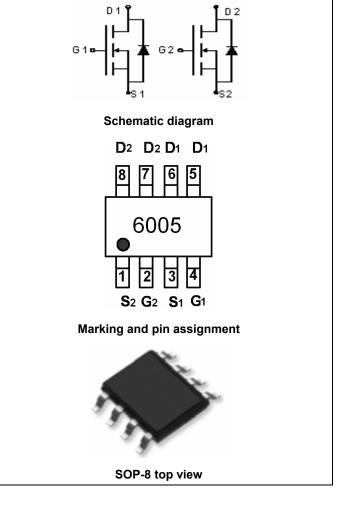
The NCE6005S uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

#### **General Features**

- $V_{DS}$  =60V, $I_{D}$  =4.5A  $R_{DS(ON)} < 45m\Omega$  @  $V_{GS}$ =10V (Typ: 38m $\Omega$ )
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Low gate to drain charge to reduce switching losses

#### **Application**

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



#### 100% ΔVds TESTED!

### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
6005	NCE6005S	SOP-8	Ø330mm	12mm	2500 units

#### Absolute Maximum Ratings (T<sub>A</sub>=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	60	V	
Gate-Source Voltage	V <sub>GS</sub>	±20	V	
Drain Current-Continuous	I <sub>D</sub>	4.5	А	
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100℃)	3.0	А	
Pulsed Drain Current	I <sub>DM</sub>	20	А	
Maximum Power Dissipation	P <sub>D</sub>	2	W	
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}$	

#### **Thermal Characteristic**

(11.1.0)			
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	62.5	°C/W
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# NCE6005S

# Electrical Characteristics (T<sub>A</sub>=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	60	69	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.2	2.0	2.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =4.5A		38	45	
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =4.5A	11	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	\/ 05\/\/ 0\/		450		PF
Output Capacitance	Coss	$V_{DS}=25V, V_{GS}=0V,$		60		PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz		25		PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	4.7	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{Ds}$ =30 $V$ , $I_{D}$ =4.5 $A$	-	2.3	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{GEN}$ =3 $\Omega$	-	15.7	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	1.9	-	nS
Total Gate Charge	Qg	\/ 00\/L 4.5A	-	8.5	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}=30V,I_{D}=4.5A,$	-	1.6	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	2.2	-	nC
Drain-Source Diode Characteristics	<u> </u>		·			-
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =3.7A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	4	Α

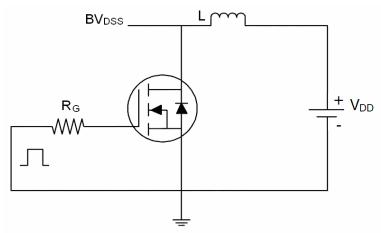
## Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

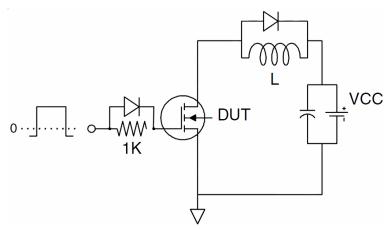


# **Test Circuit**

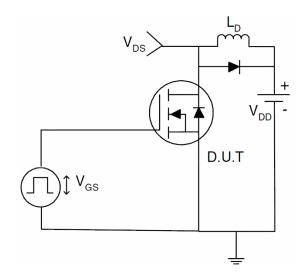
# 1) E<sub>AS</sub> test Circuits



# 2) Gate charge test Circuit



## 3) Switch Time Test Circuit

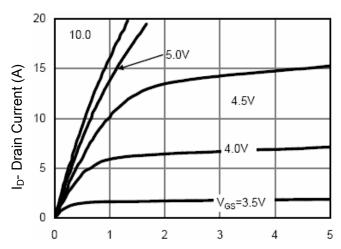


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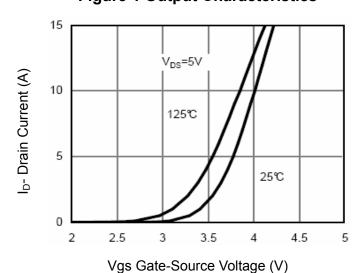


# **NCE6005S**

# **Typical Electrical and Thermal Characteristics (Curves)**



Vds Drain-Source Voltage (V) **Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

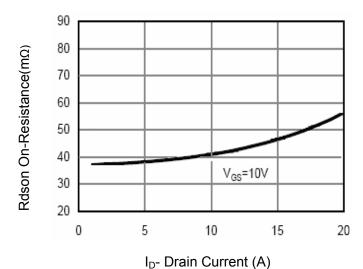
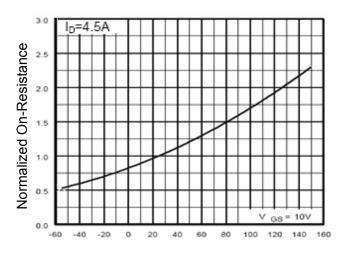


Figure 3 Rdson- Drain Current



T<sub>J</sub>-Junction Temperature(°C)

Figure 4 Rdson-JunctionTemperature

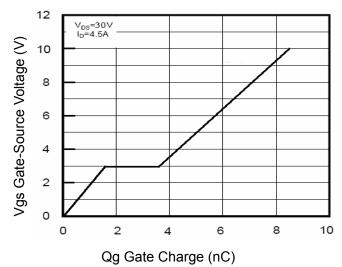


Figure 5 Gate Charge

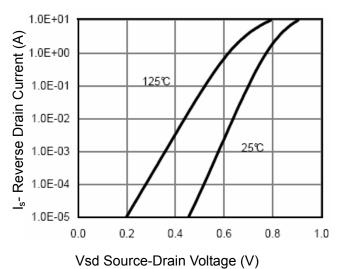


Figure 6 Source- Drain Diode Forward



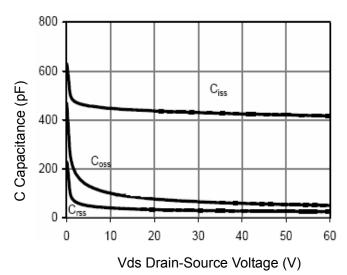


Figure 7 Capacitance vs Vds

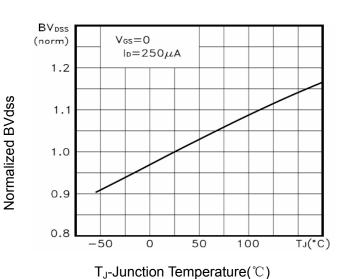


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

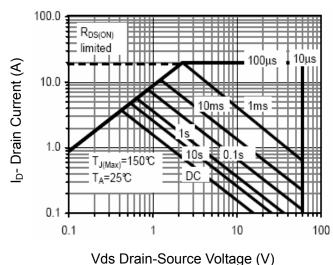
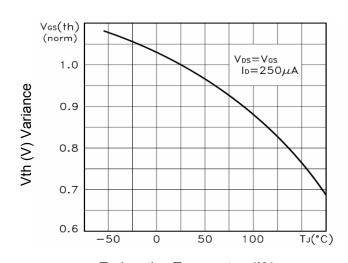
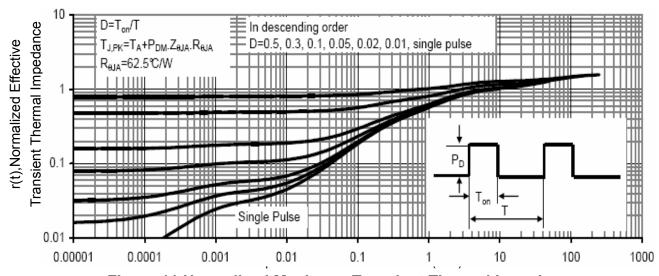


Figure 8 Safe Operation Area





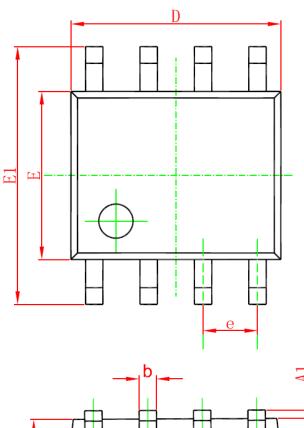
**Figure 11 Normalized Maximum Transient Thermal Impedance** 

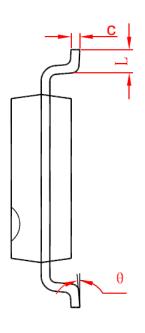
**Pb Free Product** 

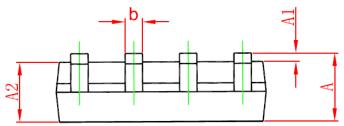


# NCE6005S

# **SOP-8 Package Information**







Symbol	Dimensions In	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1. 350	1. 750	0. 053	0. 069	
A1	0. 100	0. 250	0.004	0. 010	
A2	1. 350	1. 550	0. 053	0. 061	
b	0. 330	0. 510	0. 013	0. 020	
С	0. 170	0. 250	0.006	0. 010	
D	4. 700	5. 100	0. 185	0. 200	
E	3. 800	4. 000	0. 150	0. 157	
E1	5. 800	6. 200	0. 228	0. 244	
е	1. 270 (BSC)		0. 050 (BSC)		
L	0. 400	1. 270	0. 016	0. 050	
θ	0°	8°	0°	8°	



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